

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of

Aoyama et al.

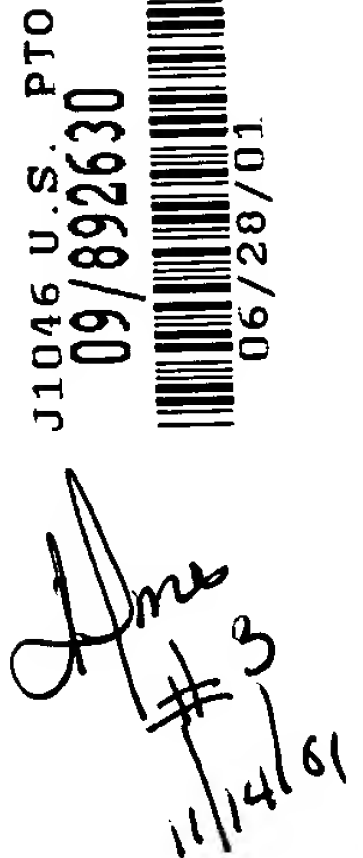
Application S/N: To be determined

Filed: Concurrently Herewith

:
:
:
:
:
:
:

New Application

For: LEAD FREE SOLDER, AND CONNECTION LEAD AND ELECTRICAL COMPONENT
USING SAID LEAD FREE SOLDER



INFORMATION DISCLOSURE STATEMENT

Honorable Assistant Commissioner
for Patents
Washington, DC 20231

Dear Sir:

In accordance with the provisions of 37 C.F.R. 1.56, 1.97 and 1.98, the attention of the Patent and Trademark Office is hereby directed to the references listed on the attached Form PTO-1449. It is respectfully requested that the references be expressly considered during the prosecution of this application, that the references be made of record therein, and that the references appear among the "References Cited" on any patent to issue therefrom.

I certify that this Information Disclosure Statement is being filed within three months of the U.S. filing date OR before the mailing date of the first Office Action on the merits. No Certification or fee is required.

Respectfully submitted,

LALOS & KEEGAN



Alfred A. Stadnicki
Registration No. 30,226

1146 Nineteenth Street, N.W.
Fifth Floor
Washington, D.C. 20036
Telephone:(202) 887-5555
Facsimile:(202) 296-1682
Date: June 28, 2001